

09-19-2007

BOX ASSIGNMENTS



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R

HEET

To the Assistant Commissioner of Patents and Trademarks:

Attorney Docket No. 2561-0070

Sir: Please Record the Attached Original Document(s) or Copy Thereof.

5-10-07

1. Name of Conveying Party(ies):

1. CHENG, Chi-Hsiung	2. CHAN, Wan-Chen	3. LI, Hsun-Fa
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Additional Name(s) of Conveying Party(ies) Attached? YES NO

TITLE OF INVENTION	METHOD AND MASK ASSEMBLY FOR FORMING SOLDER BODIES ON A SUBSTRATE
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2. Party(ies) Receiving Interest:

Name and Address	UNIVERSAL SCIENTIFIC INDUSTRIAL CO., LTD. No. 141, Lane 351, Sec. 1, Tai-Ping Rd., Tsao-Tun Chen. Nan-Tou Hsien, Taiwan
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Additional Name(s) & Address(es) of Assignee(s) Attached? YES NO

3. Nature Of Conveyance (Document):

Assignment of:	<input checked="" type="checkbox"/> Whole	<input type="checkbox"/> Part Interest
<input type="checkbox"/> Original	<input checked="" type="checkbox"/> Facsimile/Photocopy	<input type="checkbox"/> Change of Name

Execution Date(s) on the Conveyance: August 30, 2007

Execution Date(s) on the Declaration if Filed Herewith: August 30, 2007

4. Application No(s). or Patent No(s). Others on Additional Sheet(s) Attached? YES NO

App Serial No	Docket No	Inventor if not in Item 1	Patent No.	Issue Date	Inventor if not in Item 1
New Application	2561-0070	CHENG, Chi-Hsiung			

5. Name and Address of Party to Whom Correspondence Involving Document Should be Mailed: J. Scott Davidson Davidson Berquist Jackson & Gowdey, LLP 4300 Wilson Boulevard, 7 th Floor Arlington, VA 22203	7. Number Involved: Applications: 1 + Patents: 0 = Total: 1
	8. Amount of Fee Enclosed: (Code 581) Above Total x \$40.00 = \$40.00
6. Attorney Docket: 2561-0070	9. If Above Fee is Missing or Inadequate, Charge Deficiency to Deposit Account No. 501860 under Order No.: 2561-0070

10. Total number of pages including this cover sheet, attachments and document: 3

11. Statement and Signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

CUSTOMER NUMBER
42624
09/18/2007 DBYRNE 00000017 501860 11898245
01 FC:8021 40.00 DA

Davidson Berquist Jackson & Gowdey LLP
Phone: 703.894.6400 • Fax: 703.894.6430

Respectfully submitted,

By:
J. Scott Davidson
Registration No. 33,489

Date: September 10, 2007

ASSIGNMENT

This assignment agreement is applicable to an invention entitled (Invention Title)
METHOD AND MASK ASSEMBLY FOR FORMING SOLDER BODIES ON A
SUBSTRATE

The PATENT RIGHTS referred to in this agreement are:

(check one) a patent application for this invention, executed by the ASSIGNOR(S)
concurrently with this assignment.

U.S. patent application Serial No. _____, filed _____

a U.S. patent application based on PCT International Application
No. _____, filed on (date) _____ (U.S. patent
application Serial No. _____, if known)

U.S. Patent No. _____, issued _____

The PATENT RIGHTS also include all divisions, reissues, continuations and
extensions of the patents and patent applications identified above.

The PATENT RIGHTS assigned under this agreement are:

(check one) U.S. patent rights only.

Worldwide patent rights. In this case, the assignee shall have the
right to claim the benefit of the filing date of any U.S. or foreign
patent application for this invention.

The ASSIGNOR(S) referred to in this agreement is (or are) the inventor(s) whose
signature(s) appear(s) on page 2 of this Assignment and any Supplemental Sheets(s).

The ASSIGNEE referred to in this agreement is:

(Name of Assignee) UNIVERSAL SCIENTIFIC INDUSTRIAL CO., LTD.

(Address) No. 141, Lane 351, Sec. 1, Tai-Ping Rd., Tsao-Tun Chen, Nan-Tou Hsien,

Taiwan

The ASSIGNEE is:

(check one) An Individual.

A Partnership.

A Corporation of Taiwan (specify state or country)

(other) _____

The ASSIGNOR(S), in consideration of \$10.00 paid by the ASSIGNEE, and other
good and valuable consideration, receipt of which is acknowledged, hereby assign(s)
the following rights to the ASSIGNEE, its successors and assigns:

the full and exclusive right to the invention;
the entire right, title and interest in and to the PATENT RIGHTS;
the right to sue and recover for any past infringement; and,
the right to claim priority under 35 USC 119, 35 USC 120, or any other applicable provisions, based on any earlier patent applications for this invention.

As to all U.S. patent applications assigned under this agreement, the ASSIGNOR(S) hereby authorize(s) and request(s) the commissioner of Patents and Trademarks to issue all Letters Patent to the ASSIGNEE as the assignee of the entire right, title and interest, for the sole use and enjoyment of said ASSIGNEE, its successors and assigns.

Further, the ASSIGNOR(S) agree(s) to communicate to said ASSIGNEE, or its representatives, any facts known to the ASSIGNOR(S) respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation, substitute renewal, reexamination and reissue applications, execute all necessary assignment papers to cause any and all Letters Patent to be issued to said ASSIGNEE, make all rightful oaths and generally do everything necessary or desirable to aid said ASSIGNEE, its successors and assigns, to obtain and enforce proper protection for said invention.

The ASSIGNOR(S) authorize(s) any attorney and agent who has a power of attorney in this application to check any appropriate boxes and to insert the Serial Number and filing date in this document after it has been executed.

Chi-Hsiung CHENG	<i>Cheng Chi-Hsiung</i>	Aug. 30, 2007
Name of sole or first inventor	Signature	Date
Wan-Chen CHAN	<i>Chan Wan-Chen</i>	Aug. 30, 2007
Name of second inventor, if any	Signature	Date
Hsun-Fa LI	<i>LI, HSUN-FA</i>	Aug. 30, 2007
Name of third inventor, if any	Signature	Date
Name of fourth inventor, if any	Signature	Date
Name of fifth inventor, if any	Signature	Date